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# !\ REMINDERS

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- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.
- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,( automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact Taiyo Yuden Co., Ltd. for more detail in advance. Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

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- The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN' s official sales channel").
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# SUPER LOW DISTORTION MULTILAYER CERAMIC CAPACITORS (CFCAP $^{TM}$ )









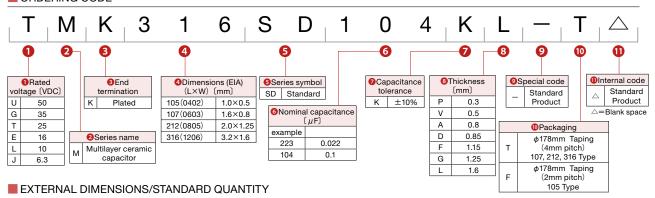
# FEATURES

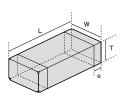
- Newly developed dielectric material and the use of nickel for internal electrodes provide superior temperature characteristics with high capacitance, small case size and low cost.
- Low distortion and low shock noise make these capacitors appropriate for use in analog or digital mobile devices.
- Superior heat-resistance, high breakdown voltage, and mechanical strength make these capacitors appropriate for replacing film capacitors.

# APPLICATIONS

- Signal line for AV products
- Analog signal coupling applications
- PLL circuit of mobile phones
- Good temperature characteristics for time constant circuits, oscillation circuits and filters

# ORDERING CODE





| Type (EIA)       |                           | W                         | т                          |                |                             | Standard qu | uantity [pcs] |
|------------------|---------------------------|---------------------------|----------------------------|----------------|-----------------------------|-------------|---------------|
| Type (EIA)       | L                         | VV                        |                            |                | е                           | Paper tape  | Embossed tape |
| □MK105           | □MK105 1.0±0.05 0.5±0.05  |                           | 0.3±0.03<br>(0.012±0.001)  | Р              | 0.25±0.10                   | 10000       | _             |
| (0402)           | (0.039±0.002)             | (0.020±0.002)             | 0.5±0.05<br>(0.020±0.002)  | 5±0.05 v (0.01 |                             | 10000       |               |
| □MK107<br>(0603) | 1.6±0.10<br>(0.063±0.004) | 0.8±0.10<br>(0.031±0.004) | 0.8±0.10<br>(0.031±0.004)  | Α              | 0.35±0.25<br>(0.014±0.010)  | 4000        | _             |
| □MK212           | 2.0±0.10                  | 1.25±0.10                 | 0.85±0.10<br>(0.033±0.004) | D              | 0.5±0.25                    | 4000        | _             |
| (0805)           | (0.079±0.004)             | (0.049±0.004)             | 1.25±0.10<br>(0.049±0.004) | G              | (0.020±0.010)               | _           | 3000          |
| □MK316           | □MK316 3.2±0.15 1.6±0.15  |                           | 1.15±0.10<br>(0.045±0.004) | F              | 0.5 +0.35                   | _           | 3000          |
| (1206)           | (0.126±0.006)             | (0.063±0.006)             | 1.6±0.20<br>(0.063±0.008)  | L              | $(0.020^{+0.014}_{-0.010})$ | _           | 2000          |

# AVAILABLE CAPACITANCE RANGE

Unit: mm(inch)

|         | Type         |     |     | 105 |     |      |     | 10  |     |     |     |     | 12  |     |     | 16  |
|---------|--------------|-----|-----|-----|-----|------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Cap     | Temp.Char    |     |     | SD  |     |      |     | S   | D   |     |     | S   | D   |     | S   | D   |
| [μĖ]    | VDC          | 50V | 25V | 16V | 10V | 6.3V | 50V | 25V | 16V | 10V | 50V | 35V | 16V | 10V | 35V | 25V |
|         | [pF:3digits] |     |     |     |     |      |     |     |     |     |     |     |     |     |     |     |
| 0.00039 | 391          | V   |     |     |     |      |     |     |     |     |     |     |     |     |     |     |
| 0.00047 | 471          | V   |     |     |     |      |     |     |     |     |     |     |     |     |     |     |
| 0.00056 | 561          | V   |     |     |     |      |     |     |     |     |     |     |     |     |     |     |
| 0.00068 | 681          |     | V   |     |     |      |     |     |     |     |     |     |     |     |     |     |
| 0.00082 | 821          |     | V   |     |     |      |     |     |     |     |     |     |     |     |     |     |
| 0.001   | 102          |     | V   |     |     |      | Α   |     |     |     |     |     |     |     |     |     |
| 0.0012  | 122          |     | V   |     |     |      | Α   |     |     |     |     |     |     |     |     |     |
| 0.0015  | 152          |     |     | V   | Р   |      | Α   |     |     |     |     |     |     |     |     |     |
| 0.0018  | 182          |     |     | V   |     |      | Α   |     |     |     |     |     |     |     |     |     |
| 0.0022  | 222          |     |     | V   |     |      | Α   |     |     |     |     |     |     |     |     |     |
| 0.0027  | 272          |     |     | V   |     | Р    | Α   |     |     |     |     |     |     |     |     |     |
| 0.0033  | 332          |     |     |     | V   |      | Α   |     |     |     |     |     |     |     |     |     |
| 0.0039  | 392          |     |     |     | V   |      |     | Α   |     |     | D   |     |     |     |     |     |
| 0.0047  | 472          |     |     |     | V   |      |     | Α   |     |     | D   |     |     |     |     |     |
| 0.0056  | 562          |     |     |     |     |      |     |     | Α   |     | D   |     |     |     |     |     |
| 0.0068  | 682          |     |     |     |     |      |     |     | Α   |     | D   |     |     |     |     |     |
| 0.0082  | 822          |     |     |     |     |      |     |     | Α   |     | D   |     |     |     |     |     |
| 0.01    | 103          |     |     |     |     |      |     |     | Α   |     | D   |     |     |     |     |     |
| 0.012   | 123          |     |     |     |     |      |     |     |     | Α   |     | D   |     |     |     |     |
| 0.015   | 153          |     |     |     |     |      |     |     |     | Α   |     | D   |     |     |     |     |
| 0.018   | 183          |     |     |     |     |      |     |     |     | Α   |     | G   |     |     |     |     |
| 0.022   | 223          |     |     |     |     |      |     |     |     | Α   |     | G   |     |     |     |     |
| 0.027   | 273          |     |     |     |     |      |     |     |     |     |     | G   |     |     |     |     |
| 0.033   | 333          |     |     |     |     |      |     |     |     |     |     |     | D   |     | F   |     |
| 0.039   | 393          |     |     |     |     |      |     |     |     |     |     |     |     |     | F   |     |
| 0.047   | 473          |     |     |     |     |      |     |     |     |     |     |     |     | D   |     | F   |
| 0.056   | 563          |     |     |     |     |      |     |     |     |     |     |     |     |     |     | F   |
| 0.068   | 683          |     |     |     |     |      |     |     |     |     |     |     |     | G   |     | F   |
| 0.082   | 823          |     |     |     |     |      |     |     |     |     |     |     |     | G   |     | L   |
| 0.1     | 104          |     |     |     |     |      |     |     |     |     |     |     |     | G   |     | L   |

<sup>\*</sup>Letters in the table indicate thickness.

<sup>\*</sup> This catalog contains the typical specification only due to the limitation of space. When you consider purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs

# PART NUMBERS

# ●105TYPE (0402 case size)

| Rated Voltage | Ordering code  | EHS<br>(Environmental<br>Hazardous<br>Substances) | Capacitance (µF) | Temperature characteristics | Dissipation factor (%) Max. | Soldering method<br>R:Reflow soldering<br>W:Wave soldering | Capacitance tolerance | Thickness<br>(mm)<br>(inch) |
|---------------|----------------|---|------------------|-----------------------------|-----------------------------|--|-----------------------|-----------------------------|
|               | UMK105 SD391KV | RoHS  | 0.00039          |                             |                             |  |                       |                             |
| 50V           | UMK105 SD471KV | RoHS  | 0.00047          |                             |                             |  |                       |                             |
|               | UMK105 SD561KV | RoHS  | 0.00056          |                             |                             |  |                       |                             |
|               | TMK105 SD681KV | RoHS  | 0.00068          |                             |                             |  |                       |                             |
| 25V           | TMK105 SD821KV | RoHS  | 0.00082          |                             |                             |  |                       | 0.5±0.05                    |
| 250           | TMK105 SD102KV | RoHS  | 0.0010           |                             |                             |  |                       | (0.020±0.002)               |
|               | TMK105 SD122KV | RoHS  | 0.0012           |                             |                             |  |                       | (0.020±0.002)               |
|               | EMK105 SD152KV | RoHS  | 0.0015           |                             |                             |  |                       |                             |
| 16V           | EMK105 SD182KV | RoHS  | 0.0018           | Standard type               | 0.1                         | R  | ±10%*                 |                             |
| 100           | EMK105 SD222KV | RoHS  | 0.0022           | 1                           |                             |  |                       |                             |
|               | EMK105 SD272KV | RoHS  | 0.0027           |                             |                             |  |                       |                             |
|               | LMK105 SD152KP | RoHS  | 0.0015           |                             |                             |  |                       | 0.3±0.03<br>(0.012±0.001)   |
| 10V           | LMK105 SD332KV | RoHS  | 0.0033           |                             |                             |  |                       | 0.5.1.0.05                  |
|               | LMK105 SD392KV | RoHS  | 0.0039           |                             |                             |  |                       | 0.5±0.05<br>(0.020±0.002)   |
|               | LMK105 SD472KV | RoHS  | 0.0047           |                             |                             |  |                       | (0.020±0.002)               |
| 6.3V          | JMK105 SD272KP | RoHS  | 0.0027           |                             |                             |  |                       | 0.3±0.03<br>(0.012±0.001)   |

<sup>\*:</sup> Capacitance tolerance J (±5%) is also available. Please contact Taiyo Yuden sales channels.

# ●107TYPE (0603 case size)

| Rated Voltage | Ordering code  | EHS<br>(Environmental<br>Hazardous<br>Substances) | Capacitance [µF] | Temperature characteristics | Dissipation factor [%] Max. | Soldering method<br>R:Reflow soldering<br>W:Wave soldering | Capacitance tolerance | Thickness<br>(mm)<br>(inch) |
|---------------|----------------|---|------------------|-----------------------------|-----------------------------|--|-----------------------|-----------------------------|
|               | UMK107 SD102KA | RoHS  | 0.0010           |                             |                             |  |                       |                             |
|               | UMK107 SD122KA | RoHS  | 0.0012           |                             |                             |  |                       |                             |
|               | UMK107 SD152KA | RoHS  | 0.0015           |                             |                             |  |                       |                             |
| 50V           | UMK107 SD182KA | RoHS  | 0.0018           |                             |                             |  |                       |                             |
|               | UMK107 SD222KA | RoHS  | 0.0022           |                             |                             |  |                       |                             |
|               | UMK107 SD272KA | RoHS  | 0.0027           |                             |                             |  |                       |                             |
|               | UMK107 SD332KA | RoHS  | 0.0033           |                             |                             |  |                       |                             |
| 25V           | TMK107 SD392KA | RoHS  | 0.0039           |                             |                             |  |                       | 0.8±0.1                     |
|               | TMK107 SD472KA | RoHS  | 0.0047           | Standard type               | 0.1                         | R  | ±10%*                 | (0.031±0.004)               |
|               | EMK107 SD562KA | RoHS  | 0.0056           |                             |                             |  |                       | (0.001=0.004)               |
| 16V           | EMK107 SD682KA | RoHS  | 0.0068           |                             |                             |  |                       |                             |
| 100           | EMK107 SD822KA | RoHS  | 0.0082           |                             |                             |  |                       |                             |
|               | EMK107 SD103KA | RoHS  | 0.010            |                             |                             |  |                       |                             |
|               | LMK107 SD123KA | RoHS  | 0.012            |                             |                             |  |                       |                             |
| 10V           | LMK107 SD153KA | RoHS  | 0.015            |                             |                             |  |                       |                             |
| 100           | LMK107 SD183KA | RoHS  | 0.018            |                             |                             |  |                       |                             |
|               | LMK107 SD223KA | RoHS  | 0.022            |                             |                             |  |                       |                             |

<sup>\*:</sup> Capacitance tolerance J (±5%) is also available. Please contact Taiyo Yuden sales channels.

# **212TYPE** (0805 case size)

| Rated Voltage | Ordering code  | EHS<br>(Environmental<br>Hazardous<br>Substances) | Capacitance [µF] | Temperature characteristics | Dissipation factor (%) Max. | Soldering method<br>R:Reflow soldering<br>W:Wave soldering | Capacitance tolerance | Thickness<br>(mm)<br>(inch) |
|---------------|----------------|---|------------------|-----------------------------|-----------------------------|--|-----------------------|-----------------------------|
|               | UMK212 SD392KD | RoHS  | 0.0039           |                             |                             |  |                       |                             |
|               | UMK212 SD472KD | RoHS  | 0.0047           |                             |                             |  |                       |                             |
| 50V           | UMK212 SD562KD | RoHS  | 0.0056           |                             |                             |  |                       |                             |
| 301           | UMK212 SD682KD | RoHS  | 0.0068           |                             |                             |  |                       | 0.85±0.1                    |
|               | UMK212 SD822KD | RoHS  | 0.0082           | ]                           |                             |  |                       | (0.033±0.004)               |
|               | UMK212 SD103KD | RoHS  | 0.01             |                             |                             |  |                       |                             |
|               | GMK212 SD123KD | RoHS  | 0.012            |                             |                             |  |                       |                             |
|               | GMK212 SD153KD | RoHS  | 0.015            | Standard type               | 0.1                         | R  | ±10%*                 |                             |
| 35V           | GMK212 SD183KG | RoHS  | 0.018            | Standard type               | 0.1                         | n  |                       | 1.05±0.1                    |
|               | GMK212 SD223KG | RoHS  | 0.022            |                             |                             |  |                       | 1.25±0.1<br>(0.049±0.004)   |
|               | GMK212 SD273KG | RoHS  | 0.027            | 1                           |                             |  |                       | (0.043±0.004)               |
| 16V           | EMK212 SD333KD | RoHS  | 0.033            | 1                           |                             |  |                       | 0.85±0.1                    |
|               | LMK212 SD473KD | RoHS  | 0.047            |                             |                             |  |                       | (0.033±0.004)               |
| 10V           | LMK212 SD683KG | RoHS  | 0.068            |                             |                             |  |                       | 1.25±0.1                    |
| 100           | LMK212 SD823KG | RoHS  | 0.082            |                             |                             |  |                       | (0.049±0.004)               |
|               | LMK212 SD104KG | RoHS  | 0.1              | 1                           |                             |  |                       | (0.043 ± 0.004)             |

 $<sup>^*</sup>$ : Capacitance tolerance J  $(\pm 5\%)$  is also available. Please contact Taiyo Yuden sales channels.

# **316TYPE** (1206 case size)

| Rated Voltage | Ordering code  | EHS<br>(Environmental<br>Hazardous<br>Substances) | Capacitance ( µF) | Temperature characteristics | Dissipation factor (%) Max. | Soldering method<br>R:Reflow soldering<br>W:Wave soldering | Capacitance tolerance | Thickness<br>(mm)<br>(inch) |
|---------------|----------------|---|-------------------|-----------------------------|-----------------------------|--|-----------------------|-----------------------------|
| 35V           | GMK316 SD333KF | RoHS  | 0.033             |                             |                             |  |                       |                             |
| 337           | GMK316 SD393KF | RoHS  | 0.039             |                             |                             |  |                       | 1.15±0.1                    |
|               | TMK316 SD473KF | RoHS  | 0.047             |                             |                             |  |                       | (0.045±0.004)               |
|               | TMK316 SD563KF | RoHS  | 0.056             | Standard type               | 0.1                         | R  | ±10%*                 | (0.040±0.004)               |
| 25V           | TMK316 SD683KF | RoHS  | 0.068             |                             |                             |  |                       |                             |
|               | TMK316 SD823KL | RoHS  | 0.082             |                             |                             |  |                       | 1.6±0.2                     |
|               | TMK316 SD104KL | RoHS  | 0.1               |                             |                             |  |                       | (0.063±0.008)               |

<sup>\*:</sup> Capacitance tolerance J (±5%) is also available. Please contact Taiyo Yuden sales channels.

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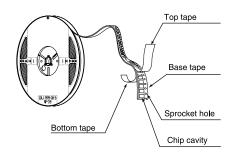
#### 1)Minimum Quantity

# Taped packaging

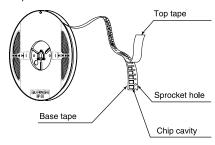
|                              | Thickness     |      | Standard q | uantity [pcs]   |  |
|------------------------------|---------------|------|------------|-----------------|--|
| Type(EIA)                    | mm(inch)      | code | Paper tape | Embossed tape   |  |
| ☐MK042(01005)                | 0.2(0.008)    | С    | 20000      |                 |  |
| ☐MK063 (0201)                | 0.3(0.012)    | P,T  | 15000      |                 |  |
| □2K096(0302)                 | 0.3(0.012)    | Р    |            |                 |  |
| ZKU96(U3UZ)                  | 0.45 (0.018)  | K    |            |                 |  |
| □WK105(0204)                 | 0.3(0.012)    | Р    | 10000      | _               |  |
|                              | 0.5(0.020)    | V    | 10000      |                 |  |
| ☐MK105(0402)                 | 0.5(0.020)    | V, W |            |                 |  |
| □VK105(0402)                 | 0.5(0.020)    | W    |            |                 |  |
| □M(407/0000)                 | 0.45(0.018)   |      | 4000       |                 |  |
| ☐MK107(0603)<br>☐WK107(0306) | 0.5(0.020)    | V    | _          | 4000            |  |
|                              | 0.8 (0.031)   | Α    |            |                 |  |
|                              | 0.5(0.020)    | V    |            |                 |  |
| □2K110 (0504)                | 0.6 (0.024)   | В    | 4000       |                 |  |
|                              | 0.8(0.031)    | Α    | 4000       | _               |  |
| □MK212(0805)                 | 0.45(0.018)   | K    |            |                 |  |
| □MK212(0805)<br>□WK212(0508) | 0.85 (0.033)  | D    |            |                 |  |
|                              | 1.25(0.049)   | G    | _          | 3000            |  |
| □4K212(0805)                 | 0.85(0.033)   | D    |            |                 |  |
| □2K212(0805)                 | 0.85 (0.033)  | D    | 4000       | _               |  |
|                              | 0.85 (0.033)  | D    |            |                 |  |
| □MK316(1206)                 | 1.15 (0.045)  | F    |            | 3000            |  |
| □IVIK316(1206)               | 1.25(0.049)   | G    | _          | 3000            |  |
|                              | 1.6 (0.063)   | L    |            |                 |  |
|                              | 0.85(0.033)   | D    |            |                 |  |
|                              | 1.15 (0.045)  | F    |            | 2000            |  |
| ☐MK325(1210)                 | 1.9(0.075)    | N    | _          |                 |  |
|                              | 2.0max(0.079) | Υ    | ]          |                 |  |
|                              | 2.5(0.098)    | М    | ]          | 500(T), 1000(P) |  |
| ☐MK432(1812)                 | 2.5(0.098)    | М    | _          | 500             |  |

# ②Taping material

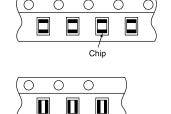
# Paper tape



# Embossed tape



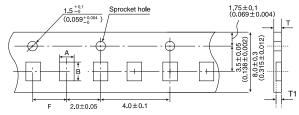




#### **3 Taping dimensions**

Paper Tape (0.315 inches wide)

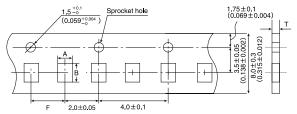
# • Pressed carrier tape (2mm pitch)



| Type(EIA)     | Chip Cavity     |                 | Insertion Pitch           | Tape Th                 | ickness                 |
|---------------|-----------------|-----------------|---------------------------|-------------------------|-------------------------|
| Type(EIA)     | Α               | В               | F                         | Т                       | T1                      |
| ☐MK042(01005) | 0.25<br>(0.010) | 0.45<br>(0.018) |                           | 0.36max.<br>(0.014)     | 0.27max.<br>(0.011)     |
| ☐MK063 (0201) | 0.37<br>(0.016) | 0.67<br>(0.027) | 2.0±0.05<br>(0.079±0.002) | 0.45max.<br>(0.018)     | 0.42max.<br>(0.017)     |
| □WK105(0204)  | 0.65<br>(0.026) | 1.15<br>(0.045) |                           | 0.45max.<br>(0.018max.) | 0.42max.<br>(0.017max.) |

Unit: mm (inch)

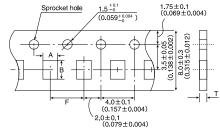
# Punched carrier tape (2mm pitch)



| Type(EIA)     | Chip (  | Cavity           | Insertion Pitch | Tape Thickness      |
|---------------|---------|------------------|-----------------|---------------------|
| Type(EIA)     | A B F   |                  | F               | Т                   |
| □2K096 (0302) | 0.72    | 1.02             |                 | 0.45max.(0.018max.) |
|               | (0.028) | (0.040) 2.0±0.05 |                 | 0.6max.(0.024max.)  |
| ☐MK105(0402)  | 0.65    | 1.15             | (0.079±0.002)   | 0.8max.             |
| ☐VK105(0402)  | (0.026) | (0.045)          |                 | (0.031max.)         |

Unit: mm (inch)

# • Punched carrier tape (4mm pitch)

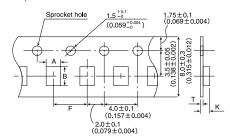


| T (EIA)                      | Chip (          | Cavity          | Insertion Pitch          | Tape Thickness         |
|------------------------------|-----------------|-----------------|--------------------------|------------------------|
| Type(EIA)                    | A B F           |                 | F                        | Т                      |
| ☐MK107(0603)<br>☐WK107(0306) | 1.0<br>(0.039)  | 1.8<br>(0.071)  |                          | 1.1max.<br>(0.043max.) |
| □2K110 (0504)                | 1.15<br>(0.045) | 1.55<br>(0.061) |                          | 1.0max.<br>(0.039max.) |
| ☐MK212(0805)<br>☐WK212(0508) | 1.65            | 2.4             | 4.0±0.1<br>(0.157±0.004) |                        |
| □4K212(0805)<br>□2K212(0805) | (0.065)         | (0.094)         |                          | 1.1max.<br>(0.043max.) |
| ☐MK316 (1206)                | 2.0<br>(0.079)  | 3.6<br>(0.142)  |                          |                        |

Unit: mm (inch)

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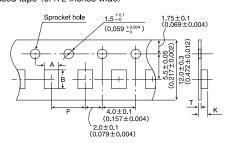
#### Embossed tape (0.315 inches wide)



| Type(EIA)     | Chip Cavity     |                | Insertion Pitch | Tape Th                | ickness                  |  |
|---------------|-----------------|----------------|-----------------|------------------------|--------------------------|--|
| Type(LIA)     | Α               | В              | F               | K                      | Т                        |  |
| □WK107(0306)  | 1.0<br>(0.039)  | 1.8<br>(0.071) |                 | 1.3max.<br>(0.051max.) | 0.25±0.1<br>(0.01±0.004) |  |
| ☐MK212(0805)  | 1.65<br>(0.065) | 2.4<br>(0.094) | 4.0±0.1         |                        |                          |  |
| □MK316 (1206) | 2.0<br>(0.079)  | 3.6<br>(0.142) | (0.157±0.004)   | 3.4max.<br>(0.134max.) | 0.6max.<br>(0.024max.)   |  |
| □MK325(1210)  | 2.8<br>(0.110)  | 3.6<br>(0.142) |                 |                        | (0.024max.)              |  |

Unit: mm (inch)

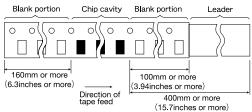
# • Embossed tape (0.472 inches wide)

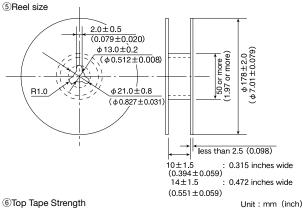


| Type(EIA)    | Chip (         | Cavity         | Insertion Pitch          | Tape Th                | ickness                |
|--------------|----------------|----------------|--------------------------|------------------------|------------------------|
| Type(EIA)    | Α              | В              | F                        | K                      | Т                      |
| ☐MK432(1812) | 3.7<br>(0.146) | 4.9<br>(0.193) | 8.0±0.1<br>(0.315±0.004) | 4.0max.<br>(0.157max.) | 0.6max.<br>(0.024max.) |

Unit: mm (inch)

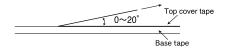
# 4 Leader and Blank portion



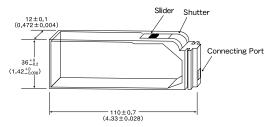


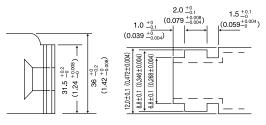
# **6**Top Tape Strength

The top tape requires a peel-off force of 0.1 to 0.7N in the direction of the arrow as illustrated below.



#### 7 Bulk Cassette





Unit: mm (inch)

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Super Low Distortion Multilayer Ceramic Capacitors (CFCAP)

Multilayer Ceramic Capacitors and Medium-High Voltage Multilayer Ceramic Capacitors are noted separately.

1. Operating Temperature Range

-55 to +125°C Specified Value

2. Storage Temperature Range

Specified Value -55 to +125°C

3. Rated Voltage

6.3VDC, 10VDC, 16VDC, 25VDC, 35VDC, 50VDC Specified Value

4. Withstanding Voltage (Between terminals)

Specified Value No breakdown or damage

[Test Methods and Remarks] Applied voltage: Rated voltage×3

Duration: 1 to 5 sec. Charge/discharge current: 50mA max.

5. Insulation Resistance

10000 MΩ or 500MΩ $\mu$ F, whichever is smaller Specified Value

[Test Methods and Remarks] Applied voltage: Rated voltage Duration: 60±5 sec.

Charge/discharge current: 50mA max.

6. Capacitance (Tolerance)

Specified Value ±10%

[Test Methods and Remarks] Measuring frequency: 1kHz±10% Measuring voltage: 1±0.2Vrms Bias application: None

7. Dissipation Factor

Specified Value 0.1%max

[Test Methods and Remarks] Measuring frequency: 1kHz±10% Measuring voltage: 1±0.2Vrms Bias application: None

8. Deflection

Appearance: No abnormality Specified Value Capacitance change: ±5%

[Test Methods and Remarks]

Warp: 1mm

Speed: 0.5mm/second Duration:10 seconds

Test board: glass epoxy resin substrate

Thickness: 1.6mm

Capacitance measurement shall be conducted with the board bent.



No terminal separation or its indication.

(Unit: mm)

# 9. Adhesive Strength of Terminal Electrodes

Specified Value

[Test Methods and Remarks] Applied force: 5N

Duration: 30 ±5 seconds



# 10. Solderability

Specified Value

At least 95% of terminal electrode is covered by new solder.

Withstanding voltage (between terminals): No abnormality

# [Test Methods and Remarks]

|                  | Solder type    | Solder temperature | Duration |
|------------------|----------------|--------------------|----------|
| Eutectic solder  | H60A or H63A   | 230±5℃             | 4±1 sec. |
| Lead-free solder | Sn-3.0Ag-0.5Cu | 245±3℃             | 4±1 Sec. |

11. Resistance to Soldering Appearance: No abnormality Capacitance change: ±2.5% max. Specified Value Dissipation factor : Initial value Insulation resistance: Initial value

[Test Methods and Remarks] Solder temp.: 270 ±5℃

Duration: 3 ±0.5 sec.

Preheating conditions : 80 to  $100^{\circ}$ C, 2 to 5 min. or 5 to 10 min. 150 to 200 $^{\circ}$ C, 2 to 5 min. or 5 to 10 min. Recovery: 24±2hrs under the standard condition

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# RELIABILITY DATA

12. Temperature Cycle (Thermal Shock) Appearance: No abnormality Capacitance change: ±2.5% max Specified Value Dissipation factor : Initial value Insulation resistance: Initial value Withstanding voltage (between terminals): No abnormality [Test Methods and Remarks] Conditions for 1 cycle / Step 1: Minimum operating temperature  $^{+0}_{-3}$ °C 30±3 min. Step 2: Room temperature 2 to 3 min. Step 3: Maximum operating temperature  $^{+0}_{-3}$ °C 30±3 min. Step 4: Room temperature 2 to 3 min Number of cycles: 5 times Recovery: 24±2hrs under the standard condition Note1 13. Humidity (Steady state) Appearance: No abnormality Capacitance change: ±5% max Dissipation factor: 0.5% max Specified Value Insulation resistance  $50M\Omega\mu\text{F}$  or  $1000M\Omega$ , whichever is smaller [Test Methods and Remarks] Temperature:40±2℃ Humidity:90 to 95% RH Duration:500  $^{+24}_{-0}$  hrs Recovery: 24 ±2hrs under the standard condition 14. Humidy Loading Appearance: No abnormality Capacitance change: ±7.5% max Dissipation factor: 0.5% max Specified Value Insulation resistance:  $25M\Omega\mu\text{F}$  or  $500M\Omega$ , whichever is smaller Test Methods and Remarks According to JIS C 5102 clause 9.9. Temperature:40±2°C Humidity:90 to 95% RH Duration:500 +0.2 C Authority.90 to Duration:500 +0.2 hrs
Applied voltage: Rated voltage
Charge/discharge current:50mA max Recovery: 24 ±2hrs under the standard condition 15. High Temperature Loading Appearance: No abnormality Capacitance change: ±3% max Specified Value Dissipation factor: 0.35% max Insulation resistance:  $50M\Omega\mu$ F or  $1000M\Omega$ , whichever is smaller [Test Methods and Remarks] According to JIS C 5102 clause 9.10. Temperature:125±3°C Duration:1000 <sup>+48</sup><sub>-0</sub> hrs Applied voltage: Rated voltage x 2
Charge/discharge current:50mA max Recovery: 24 ±2hrs under the standard condition Note1

Note1 Standard condition: Temperature: 5 to 35°C, Relative humidity: 45 to 85 % RH, Air pressure: 86 to 106kPa

When there are questions concerning measurement results, in order to provide correlation data, the test shall be conducted under the following condition.

Temperature: 20±2°C, Relative humidity: 60 to 70 % RH, Air pressure: 86 to 106kPa Unless otherwise specified, all the tests are conducted under the "standard condition".

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#### 1. Circuit Design

- ◆Verification of operating environment, electrical rating and performance
- 1. A malfunction of equipment in fields such as medical, aerospace, nuclear control, etc. may cause serious harm to human life or have severe social ramifications. Therefore, any capacitors to be used in such equipment may require higher safety and reliability, and shall be clearly differentiated from them used in general purpose applications.

- ◆Operating Voltage (Verification of Rated voltage)

  1. The operating voltage for capacitors must always be their rated voltage or less.
  - If an AC voltage is loaded on a DC voltage, the sum of the two peak voltages shall be the rated voltage or less.
- For a circuit where an AC or a pulse voltage may be used, the sum of their peak voltages shall also be the rated voltage or less.

  2. Even if an applied voltage is the rated voltage or less reliability of capacitors may be deteriorated in case that either a high frequency AC voltage or a pulse voltage having rapid rise time is used in a circuit.

#### 2. PCB Design

Precautions

- ◆Pattern configurations (Design of Land-patterns)

  1. When capacitors are mounted on PCBs, the amount of solder used (size of fillet) can directly affect the capacitor performance. Therefore, the following items must be carefully considered in the design of land patterns:
  - (1) Excessive solder applied can cause mechanical stresses which lead to chip breaking or cracking. Therefore, please consider appropriate land-patterns for proper amount of solder.
- (2) When more than one component are jointly soldered onto the same land, each component's soldering point shall be separated by solder-resist.

  Pattern configurations (Capacitor layout on PCBs)

After capacitors are mounted on boards, they can be subjected to mechanical stresses in subsequent manufacturing processes (PCB cutting, board inspection, mounting of additional parts, assembly into the chassis, wave soldering of the boards, etc.). For this reason, land pattern configurations and positions of capacitors shall be carefully considered to minimize stresses.

- ◆Pattern configurations (Design of Land-patterns)
  - The following diagrams and tables show some examples of recommended land patterns to prevent excessive solder amounts.
  - (1) Recommended land dimensions for typical chip capacitors
  - ●Multilayer Ceramic Capacitors: Recommended land dimensions (unit: mm) Wave-soldering

| Type   |             | 107        | 212        | 316        | 325        |  |
|--------|-------------|------------|------------|------------|------------|--|
| Size   | _ L 1.6 2.0 |            | 3.2        | 3.2        |            |  |
| Size W |             | 0.8        | 1.25       | 1.6        | 2.5        |  |
| A      |             | 0.8 to 1.0 | 1.0 to 1.4 | 1.8 to 2.5 | 1.8 to 2.5 |  |
| В      |             | 0.5 to 0.8 | 0.8 to 1.5 | 0.8 to 1.7 | 0.8 to 1.7 |  |
| С      |             | 0.6 to 0.8 | 0.9 to 1.2 | 1.2 to 1.6 | 1.8 to 2.5 |  |

#### Reflow-soldering

| Тур  | е | 042          | 063          | 105          | 107        | 212        | 316        | 325        | 432        |
|------|---|--------------|--------------|--------------|------------|------------|------------|------------|------------|
| 0:   | L | 0.4          | 0.6          | 1.0          | 1.6        | 2.0        | 3.2        | 3.2        | 4.5        |
| Size | W | 0.2          | 0.3          | 0.5          | 0.8        | 1.25       | 1.6        | 2.5        | 3.2        |
| Α    |   | 0.15 to 0.25 | 0.20 to 0.30 | 0.45 to 0.55 | 0.8 to 1.0 | 0.8 to 1.2 | 1.8 to 2.5 | 1.8 to 2.5 | 2.5 to 3.5 |
| В    |   | 0.15 to 0.20 | 0.20 to 0.30 | 0.40 to 0.50 | 0.6 to 0.8 | 0.8 to 1.2 | 1.0 to 1.5 | 1.0 to 1.5 | 1.5 to 1.8 |
| С    |   | 0.15 to 0.30 | 0.25 to 0.40 | 0.45 to 0.55 | 0.6 to 0.8 | 0.9 to 1.6 | 1.2 to 2.0 | 1.8 to 3.2 | 2.3 to 3.5 |

## ●LWDC: Recommended land dimensions for reflow-soldering (unit: mm)

| Type |   | 105          | 107         | 212        |  |
|------|---|--------------|-------------|------------|--|
| Size | L | 0.52         | 0.8         | 1.25       |  |
| Size | W | 1.0          | 1.6         | 2.0        |  |
| Α    |   | 0.18 to 0.22 | 0.25 to 0.3 | 0.5 to 0.7 |  |
| В    |   | 0.2 to 0.25  | 0.3 to 0.4  | 0.4 to 0.5 |  |
| С    |   | 0.9 to 1.1   | 1.5 to 1.7  | 1.9 to 2.1 |  |

(unit: mm)

Technical consider-

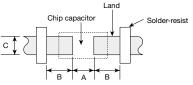
## ●Array type: Recommerded land dimensions for reflow-soldering (unit: mm)

| Тур   | Type 096 (2 circuits) 110 (2 circuits) 212 (2 circuits |                           | 212 (2 circuits) | 212 (4 circuits) |            |
|-------|--|---------------------------|------------------|------------------|------------|
| Size  | L  | 0.9                       | 1.37             | 2.0              | 2.0        |
| Size  | W  | 0.6                       | 1.0              | 1.25             | 1.25       |
| а     |  | 0.25 to 0.35              | 0.35 to 0.45     | 0.5 to 0.6       | 0.5 to 0.6 |
| b     | b 0.15 to 0.25   |                           | 0.55 to 0.65     | 0.5 to 0.6       | 0.5 to 0.6 |
| С     |  | c 0.15 to 0.25 0.3 to 0.4 |                  | 0.5 to 0.6       | 0.2 to 0.3 |
| d 0.4 |  | 0.45                      | 0.64             | 1.0              | 0.5        |

# (2) Examples of good and bad solder application

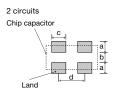
| Items   | Not recommended                           | Recommended   |
|---|---|---------------|
| Mixed mounting of SMD and leaded components                             | Lead wire of component                    | Solder-resist |
| Component placement close to the chassis                                | Chassis — Solder(for grounding)  Land     | Solder-resist |
| Hand-soldering<br>of leaded<br>components<br>near mounted<br>components | Lead wire of component-<br>Soldering iron | Solder-resist |
| Horizontal<br>component<br>placement                                    |   | Solder-resist |











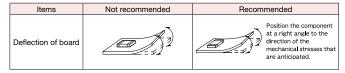


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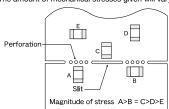
#### 2. PCB Design

- ◆Pattern configurations (Capacitor layout on PCBs)
- 1-1. The following are examples of good and bad capacitor layouts; capacitors shall be located to minimize any possible mechanical stresses from board warp or deflection.



Technical considerations

1-2. The amount of mechanical stresses given will vary depending on capacitor layout. Please refer to diagram below.



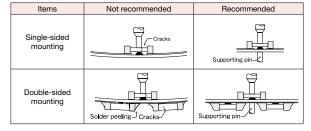
1-3. When PCB is split, the amount of mechanical stress on the capacitors can vary according to the method used. The following methods are listed in order from least stressful to most stressful: push-back, slit, V-grooving, and perforation. Thus, please consider the PCB, split methods as well as chip location.

## 3. Mounting

- ◆Adjustment of mounting machine
  - When capacitors are mounted on PCB, excessive impact load shall not be imposed on them.
- 2. Maintenance and inspection of mounting machines shall be conducted periodically. ◆Selection of Adhesives

#### Precautions

- 1. When chips are attached on PCBs with adhesives prior to soldering, it may cause capacitor characteristics degradation unless the following factors are appropriately checked: size of land patterns, type of adhesive, amount applied, hardening temperature and hardening period. Therefore, please contact us for further information.
- ◆Adjustment of mounting machine
- 1. When the bottom dead center of a pick-up nozzle is too low, excessive force is imposed on capacitors and causes damages. To avoid this, the following points shall be considerable.
  - The bottom dead center of the pick-up nozzle shall be adjusted to the surface level of PCB without the board deflection.
- (2) The pressure of nozzle shall be adjusted between 1 and 3 N static loads.
  (3) To reduce the amount of deflection of the board caused by impact of the pick-up nozzle, supporting pins or back-up pins shall be used on the other side of the PCB. The following diagrams show some typical examples of good and bad pick-up nozzle placement:



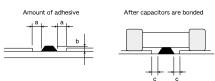
Technical consider ations

- As the alignment pin is worn out, adjustment of the nozzle height can cause chipping or cracking of capacitors because of mechanical impact on the capacitors. To avoid this, the monitoring of the width between the alignment pins in the stopped position, maintenance, check and replacement of the pin shall be conducted
- ◆Selection of Adhesives

Some adhesives may cause IR deterioration. The different shrinkage percentage of between the adhesive and the capacitors may result in stresses on the capacitors and lead to cracking. Moreover, too little or too much adhesive applied to the board may adversely affect components. Therefore, the following precautions shall be noted in the application of adhesives.

- (1) Required adhesive characteristics
- a. The adhesive shall be strong enough to hold parts on the board during the mounting & solder process. b. The adhesive shall have sufficient strength at high temperatures.
- The adhesive shall have good coating and thickness consistency. d. The adhesive shall be used during its prescribed shelf life.
- e. The adhesive shall harden rapidly.
- f. The adhesive shall have corrosion resistance
- g. The adhesive shall have excellent insulation characteristics.
  h. The adhesive shall have no emission of toxic gasses and no effect on the human body.
- (2) The recommended amount of adhesives is as follows;

[Recommended condition] 212/316 case sizes as examples Figure 0.3mm min а 100 to 120  $\mu m$ b С Adhesives shall not contact land



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#### Selection of Flux

- Since flux may have a significant effect on the performance of capacitors, it is necessary to verify the following conditions prior to use;
  - (1) Flux used shall be less than or equal to 0.1 wt% (in CI equivalent) of halogenated content. Flux having a strong acidity content shall not be applied. (2) When shall capacitors are soldered on boards, the amount of flux applied shall be controlled at the optimum level.
  - (3) When water-soluble flux is used, special care shall be taken to properly clean the boards.

#### Precautions

Temperature, time, amount of solder, etc. shall be set in accordance with their recommended conditions.

Sn-Zn solder paste can adversely affect MLCC reliability.

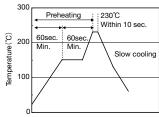
Please contact us prior to usage of Sn-Zn solder.

- 1-1. When too much halogenated substance (Chlorine, etc.) content is used to activate flux, or highly acidic flux is used, it may lead to comosion of terminal electrodes or degradation of insulation resistance on the surfaces of the capacitors.
- 1-2. Flux is used to increase solderability in wave soldering. However if too much flux is applied, a large amount of flux gas may be emitted and may adversely affect the solderability. To minimize the amount of flux applied, it is recommended to use a flux-bubbling system.
- 1-3. Since the residue of water-soluble flux is easily dissolved in moisture in the air, the residues on the surfaces of capacitors in high humidity conditions may cause a degradation of insulation resistance and reliability of the capacitors. Therefore, the cleaning methods and the capability of the machines used shall also be considered carefully when water-soluble flux is used.

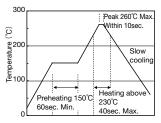
- Ceramic chip capacitors are susceptible to thermal shock when exposed to rapid or concentrated heating or rapid cooling.
- Therefore, the soldering must be conducted with great care so as to prevent malfunction of the components due to excessive thermal shock
- Preheating: Capacitors shall be preheated sufficiently, and the temperature difference between the capacitors and solder shall be within 100 to 130°C.
  Cooling: The temperature difference between the capacitors and cleaning process shall not be greater than 100°C.

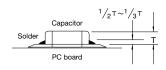
#### [Reflow soldering]

[Recommended conditions for eutectic soldering]



[Recommended condition for Pb-free soldering]





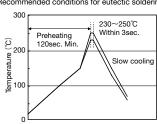
## Caution

- (1) The ideal condition is to have solder mass (fillet) controlled to 1/2 to 1/3 of the thickness of a capacitor.
- Because excessive dwell times can adversely affect solderability, soldering duration shall be kept as close to recommended times as possible.

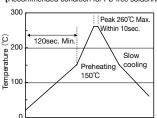
#### Technical considerations

## [Wave soldering]

[Recommended conditions for eutectic soldering]



[Recommended condition for Pb-free soldering]

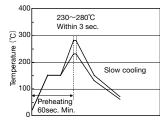


## Caution

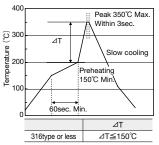
Wave soldering must not be applied to capacitors designated as for reflow soldering only.

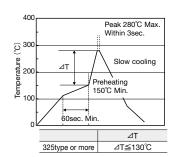
# [Hand soldering]

[Recommended conditions for eutectic soldering]



[Recommended condition for Pb-free soldering]





## Caution

- Use a 50W soldering iron with a maximum tip diameter of 1.0 mm.
- ②The soldering iron shall not directly touch capacitors

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#### ◆Cleaning conditions 1. When PCBs are cleaned after capacitors mounting, Please select the appropriate cleaning solution in accordance with the intended use of the cleaning. (e.g. to Precautions remove soldering flux or other materials from the production process.) 2. Cleaning condition shall be determined after it is verified by using actual cleaning machine that the cleaning process does not affect capacitor's characteristics. 1. The use of inappropriate cleaning solutions can cause foreign substances such as flux residue to adhere to capacitors or deteriorate their outer coating, resulting in a degradation of the capacitor's electrical properties (especially insulation resistance) 2. Inappropriate cleaning conditions (insufficient or excessive cleaning) may adversely affect the performance of the capacitors. In the case of ultrasonic cleaning, too much power output can cause excessive vibration of PCBs which may lead to the cracking of capacitors or the soldered Technical considerportion, or decrease the terminal electrodes' strength. Therefore, the following conditions shall be carefully checked; ations Ultrasonic output : 20 W/ℓ or less Ultrasonic frequency: 40 kHz or less Ultrasonic washing period : 5 min. or less 6. Resin coating and mold 1. With some type of resins, decomposition gas or chemical reaction vapor may remain inside the resin during the hardening period or while left under normal storage conditions resulting in the deterioration of the capacitor's performance Precautions 2. When a resin's hardening temperature is higher than capacitor's operating temperature, the stresses generated by the excessive heat may lead to damage or destruction of capacitors. The use of such resins, molding materials etc. is not recommended 7. Handling ◆Splitting of PCB 1. When PCBs are split after components mounting, care shall be taken so as not to give any stresses of deflection or twisting to the board. 2. Board separation shall not be done manually, but by using the appropriate devices. Precautions ◆Mechanical considerations Be careful not to subject capacitors to excessive mechanical shocks. (1) If ceramic capacitors are dropped onto a floor or a hard surface, they shall not be used. (2) Please be careful that the mounted components do not come in contact with or bump against other boards or components. 8. Storage conditions **♦**Storage 1. To maintain the solderability of terminal electrodes and to keep packaging materials in good condition, care must be taken to control temperature and humidity in the storage area. Humidity should especially be kept as low as possible. Recommended conditions Ambient temperature · Below 70% BH Precautions Humidity The ambient temperature must be kept below 40°C. Even under ideal storage conditions, solderability of capacitor is deteriorated as time passes, so capacitors shall be used within 6 months from the time of delivery. Ceramic chip capacitors shall be kept where no chlorine or sulfur exists in the air. 2. The capacitance values of high dielectric constant capacitors will gradually decrease with the passage of time, So care shall be taken to design circuits . Even if capacitance value decreases as time passes, it will get back to the initial value by a heat treatment at 150°C for 1hour. If capacitors are stored in a high temperature and humidity environment, it might rapidly cause poor solderability due to terminal oxidation and quality loss of taping/ considerpackaging materials. For this reason, capacitors shall be used within 6 months from the time of delivery. If exceeding the above period, please check solderability beations fore using the capacitors.

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